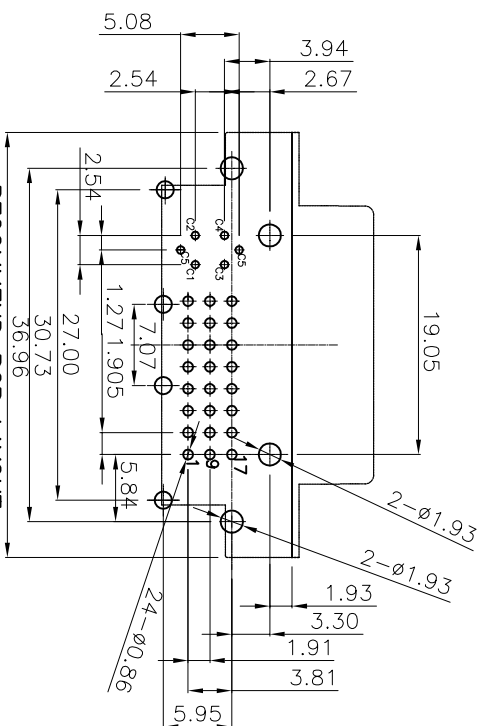
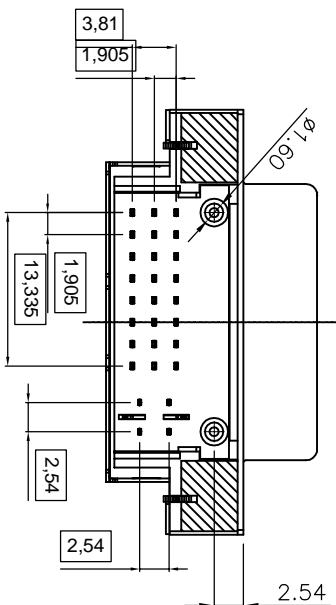


1. HOUSING: THERMOPLASTIC (UL 94V-0).
2. COVER: THERMOPLASTIC (UL 94V-0).
3. TERMINAL: COPPER ALLOY,
GOLD PLATED ON CONTACT AREA,
TIN PLATED ON SOLDER TAILS,
NICKEL UNDER PLATED OVERALL.
4. BOARD LOCK: SPCC, TIN PLATED OVER NICKEL.
5. SHELL: SPCC, NICKEL PLATED OVERALL.
6. RIVET: Zn ALLOY, NICKEL PLATED OVERALL.



RECOMMEND PCB LAYOUT
TOLERANCE: ± 0.05
TOP VIEW

X ₁ ±0.50	APPD:	TITLE: 29P1IN 焊板式 母头+后铁壳 +D型铜箔
X ₂ ±0.20	Mr.wu	
.XX ±0.10	CHKD:	
XXX±0.05	Mr.wu	
X ₃ ±.27	DR:	PART NO:
X ₄ ±1'	Gus cheng	JTIONS-0036

A	JIONS-DV-0009		2011/02/01			DWG NO:	SHEET:0F
REV	ECH NO	DESCRIPTION	DATE			WWW.JIONS.COM.CN	客户图
北京玖思启明电子科技有限公司							
						UNITS:	SCALE:
				mm		1:1	REV:

Jions 北京玖思启明电子科技有限公司